BB187

VHF variable capacitance diode

Rev. 5 — 6 September 2011 Product data sheet

1. Product profile

1.1 General description

The BB187 is a planar technology variable capacitance diode, in a SOD523 (SC-79) ultra small plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

1.2 Features and benefits

- High linearity
- Excellent matching to 2 % DMA
- Ultra small plastic SMD package
- $C_{d(25V)}$: 2.75 pF; $C_{d(2V)}$ to $C_{d(25V)}$ ratio: minimum 11
- Low series resistance.

1.3 Applications

- Electronic tuning in VHF television tuners
- Voltage Controlled Oscillators (VCO).

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline[1]	Symbol
1	cathode		
2	anode		sym008

[1] The marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB187	SC-79	plastic surface mounted package; 2 leads	SOD523

4. Marking

Table 3. Marking

Type number	Marking code
BB187	X

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

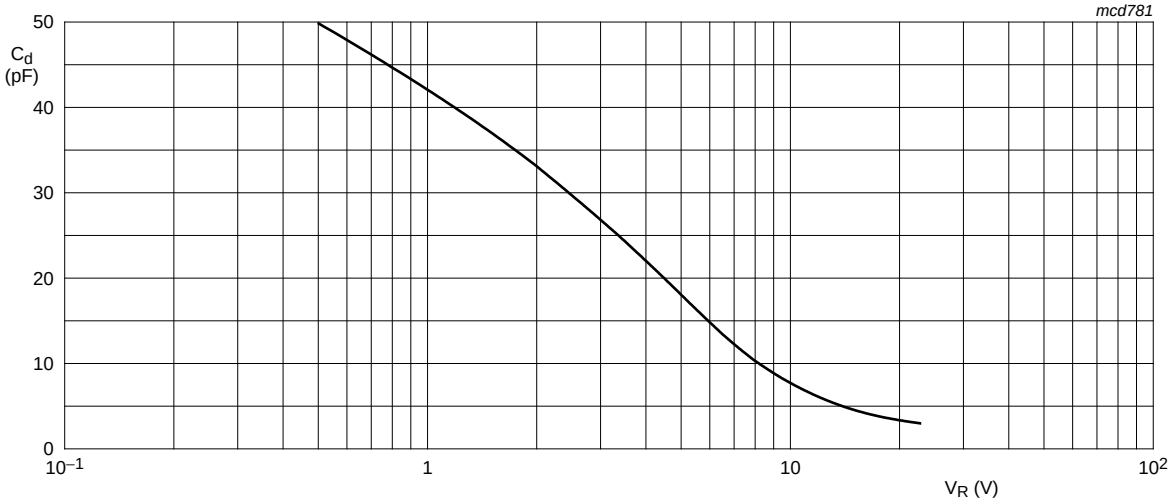
Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	32	V
V_{RM}	peak reverse voltage	in series with a 10 kΩ resistor	-	35	V
I_F	forward current		-	20	mA
T_{stg}	storage temperature		–55	+150	°C
T_j	junction temperature		–55	+125	°C

6. Characteristics

Table 5. Characteristics

T_j = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_R	reverse current	see Figure 2	-	-		
		V_R = 30 V	-	-	10	nA
		V_R = 30 V; T_j = 85 °C	-	-	200	nA
r_s	diode series resistance	f = 470 MHz; V_R = 5 V	-	-	0.75	Ω
C_d	diode capacitance	f = 1 MHz; see Figure 1 and Figure 3				
		V_R = 2 V	29.3	-	34.2	pF
		V_R = 25 V	2.57	2.75	2.92	pF
$\frac{C_{d(2V)}}{C_{d(25V)}}$	capacitance ratio	f = 1 MHz	11	-	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	V_R = 2 V to 25 V; in a sequence of 10 diodes (gliding)	-	-	2	%



f = 1 MHz; T_j = 25 °C.

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

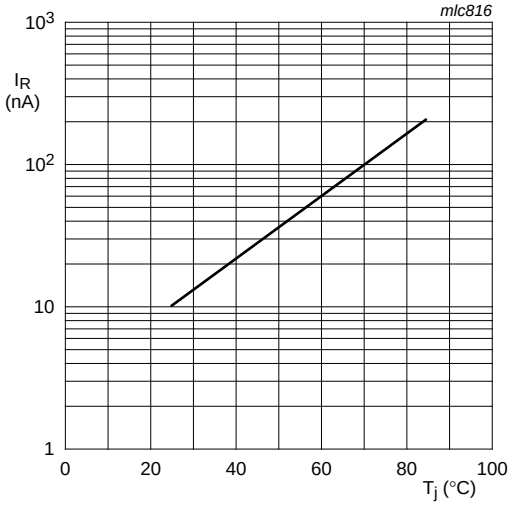


Fig 2. Reverse current as a function of junction temperature; maximum values.

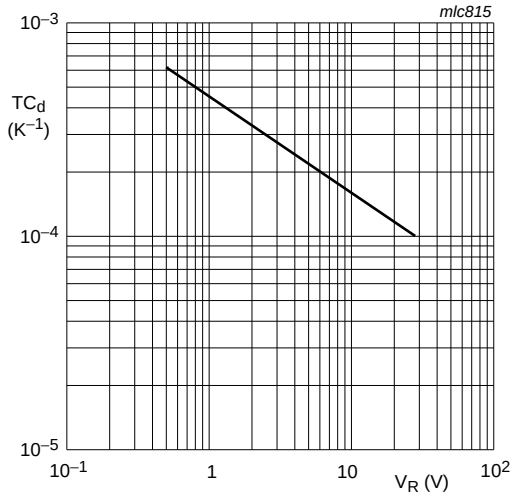
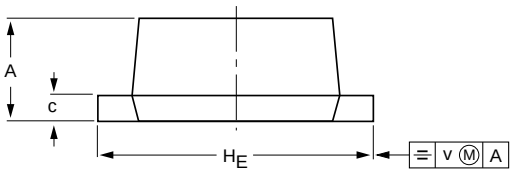
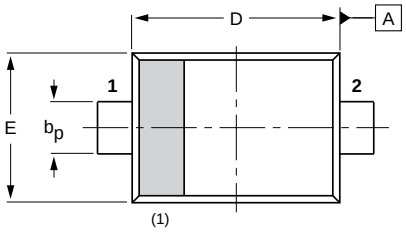


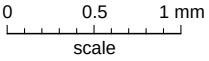
Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

7. Package outline

Plastic surface-mounted package; 2 leads **SOD523**







DIMENSIONS (mm are the original dimensions)

UNIT	A	b_p	c	D	E	H_E	v
mm	0.65 0.58	0.34 0.26	0.17 0.11	1.25 1.15	0.85 0.75	1.65 1.55	0.1

Note

1. The marking bar indicates the cathode.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOD523			SC-79			~~02-12-13~~ 06-03-16

Fig 4. Package outline SOD523 (SC-79).

8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB187 v.5	20110906	Product data sheet	-	BB187 v.4
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Package outline drawings have been updated to the latest version.			
BB187 v.4 (9397 750 13835)	20041103	Product data sheet	-	BB187 v.3
BB187 v.3 (9397 750 09385)	20020220	Product specification	-	BB187 v.2
BB187 v.2 (9397 750 06459)	19991019	Product specification	-	BB187 v.1
BB187 v.1 (9397 750 06307)	19990915	Preliminary specification	-	-

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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11. Contents

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